# E·XFL

#### Intel - 10AS027E2F29I1HG Datasheet



Welcome to E-XFL.COM

Embedded - System On Chip (SoC): The Heart of Modern Embedded Systems

**Embedded - System On Chip (SoC)** refers to an integrated circuit that consolidates all the essential components of a computer system into a single chip. This includes a microprocessor, memory, and other peripherals, all packed into one compact and efficient package. SoCs are designed to provide a complete computing solution, optimizing both space and power consumption, making them ideal for a wide range of embedded applications.

#### What are Embedded - System On Chip (SoC)?

**System On Chip (SoC)** integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions. SoCs combine a central

#### Details

Product Status	Active
Architecture	MCU, FPGA
Core Processor	Dual ARM® Cortex®-A9 MPCore <sup>™</sup> with CoreSight <sup>™</sup>
Flash Size	-
RAM Size	256КВ
Peripherals	DMA, POR, WDT
Connectivity	EBI/EMI, Ethernet, I <sup>2</sup> C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	1.5GHz
Primary Attributes	FPGA - 270K Logic Elements
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	780-BBGA, FCBGA
Supplier Device Package	780-FBGA, FC (29x29)
Purchase URL	https://www.e-xfl.com/product-detail/intel/10as027e2f29i1hg

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong





# Contents

	_
Intel <sup>®</sup> Arria <sup>®</sup> 10 Device Overview	
Key Advantages of Intel Arria 10 Devices	
Summary of Intel Arria 10 Features	
Intel Arria 10 Device Variants and Packages	
Intel Arria 10 GX	7
I/O Vertical Migration for Intel Arria 10 Devices	
Adaptive Logic Module	
Variable-Precision DSP Block	
Embedded Memory Blocks	
Embedded Memory Capacity in Intel Arria 1	0 Devices
Embedded Memory Configurations for Single	e-port Mode 22
Clock Networks and PLL Clock Sources	
Clock Networks	
FPGA General Purpose I/O	
External Memory Interface	
	10 Devices 24
PCIe Gen1, Gen2, and Gen3 Hard IP	
Enhanced PCS Hard IP for Interlaken and 10 Gbps	Ethernet26
Interlaken Support	
10 Gbps Ethernet Support	
Low Power Serial Transceivers	27
Transceiver Channels	
PMA Features	
PCS Features	
SoC with Hard Processor System	
Key Advantages of 20-nm HPS	
Features of the HPS	
FPGA Configuration and HPS Booting	
Hardware and Software Development	
Dynamic and Partial Reconfiguration	
Dynamic Reconfiguration	
Partial Reconfiguration	
Enhanced Configuration and Configuration via Prot	ocol
SEU Error Detection and Correction	
Power Management	
Incremental Compilation	
Document Revision History for Intel Arria 10 Devic	e Overview40



# Intel<sup>®</sup> Arria<sup>®</sup> 10 Device Overview

The Intel<sup>®</sup> Arria<sup>®</sup> 10 device family consists of high-performance and power-efficient 20 nm mid-range FPGAs and SoCs.

Intel Arria 10 device family delivers:

- Higher performance than the previous generation of mid-range and high-end FPGAs.
- Power efficiency attained through a comprehensive set of power-saving technologies.

The Intel Arria 10 devices are ideal for high performance, power-sensitive, midrange applications in diverse markets.

Market	Applications
Wireless	<ul><li>Channel and switch cards in remote radio heads</li><li>Mobile backhaul</li></ul>
Wireline	<ul> <li>40G/100G muxponders and transponders</li> <li>100G line cards</li> <li>Bridging</li> <li>Aggregation</li> </ul>
Broadcast	<ul> <li>Studio switches</li> <li>Servers and transport</li> <li>Videoconferencing</li> <li>Professional audio and video</li> </ul>
Computing and Storage	<ul><li>Flash cache</li><li>Cloud computing servers</li><li>Server acceleration</li></ul>
Medical	<ul><li>Diagnostic scanners</li><li>Diagnostic imaging</li></ul>
Military	<ul> <li>Missile guidance and control</li> <li>Radar</li> <li>Electronic warfare</li> <li>Secure communications</li> </ul>

#### Table 1. Sample Markets and Ideal Applications for Intel Arria 10 Devices

#### **Related Information**

Intel Arria 10 Device Handbook: Known Issues Lists the planned updates to the *Intel Arria 10 Device Handbook* chapters.

Intel Corporation. All rights reserved. Intel, the Intel logo, Altera, Arria, Cyclone, Enpirion, MAX, Nios, Quartus and Stratix words and logos are trademarks of Intel Corporation or its subsidiaries in the U.S. and/or other countries. Intel warrants performance of its FPGA and semiconductor products to current specifications in accordance with Intel's standard warranty, but reserves the right to make changes to any products and services at any time without notice. Intel assumes no responsibility or liability arising out of the application or use of any information, product, or service described herein except as expressly agreed to in writing by Intel. Intel customers are advised to obtain the latest version of device specifications before relying on any published information and before placing orders for products or services.





# **Key Advantages of Intel Arria 10 Devices**

#### Table 2. Key Advantages of the Intel Arria 10 Device Family

Advantage	Supporting Feature
Enhanced core architecture	<ul> <li>Built on TSMC's 20 nm process technology</li> <li>60% higher performance than the previous generation of mid-range FPGAs</li> <li>15% higher performance than the fastest previous-generation FPGA</li> </ul>
High-bandwidth integrated transceivers	<ul> <li>Short-reach rates up to 25.8 Gigabits per second (Gbps)</li> <li>Backplane capability up to 12.5 Gbps</li> <li>Integrated 10GBASE-KR and 40GBASE-KR4 Forward Error Correction (FEC)</li> </ul>
Improved logic integration and hard IP blocks	<ul> <li>8-input adaptive logic module (ALM)</li> <li>Up to 65.6 megabits (Mb) of embedded memory</li> <li>Variable-precision digital signal processing (DSP) blocks</li> <li>Fractional synthesis phase-locked loops (PLLs)</li> <li>Hard PCI Express Gen3 IP blocks</li> <li>Hard memory controllers and PHY up to 2,400 Megabits per second (Mbps)</li> </ul>
Second generation hard processor system (HPS) with integrated ARM* Cortex*-A9* MPCore* processor	<ul> <li>Tight integration of a dual-core ARM Cortex-A9 MPCore processor, hard IP, and an FPGA in a single Intel Arria 10 system-on-a-chip (SoC)</li> <li>Supports over 128 Gbps peak bandwidth with integrated data coherency between the processor and the FPGA fabric</li> </ul>
Advanced power savings	<ul> <li>Comprehensive set of advanced power saving features</li> <li>Power-optimized MultiTrack routing and core architecture</li> <li>Up to 40% lower power compared to previous generation of mid-range FPGAs</li> <li>Up to 60% lower power compared to previous generation of high-end FPGAs</li> </ul>

# **Summary of Intel Arria 10 Features**

#### Table 3. Summary of Features for Intel Arria 10 Devices

Feature	Description
Technology	<ul> <li>TSMC's 20-nm SoC process technology</li> <li>Allows operation at a lower V<sub>CC</sub> level of 0.82 V instead of the 0.9 V standard V<sub>CC</sub> core voltage</li> </ul>
Packaging	<ul> <li>1.0 mm ball-pitch Fineline BGA packaging</li> <li>0.8 mm ball-pitch Ultra Fineline BGA packaging</li> <li>Multiple devices with identical package footprints for seamless migration between different FPGA densities</li> <li>Devices with compatible package footprints allow migration to next generation high-end Stratix<sup>®</sup> 10 devices</li> <li>RoHS, leaded<sup>(1)</sup>, and lead-free (Pb-free) options</li> </ul>
High-performance FPGA fabric	<ul> <li>Enhanced 8-input ALM with four registers</li> <li>Improved multi-track routing architecture to reduce congestion and improve compilation time</li> <li>Hierarchical core clocking architecture</li> <li>Fine-grained partial reconfiguration</li> </ul>
Internal memory blocks	<ul> <li>M20K—20-Kb memory blocks with hard error correction code (ECC)</li> <li>Memory logic array block (MLAB)—640-bit memory</li> </ul>
	continued

<sup>&</sup>lt;sup>(1)</sup> Contact Intel for availability.



Feature		Description
Embedded Hard IP blocks	Variable-precision DSP	<ul> <li>Native support for signal processing precision levels from 18 x 19 to 54 x 54</li> <li>Native support for 27 x 27 multiplier mode</li> <li>64-bit accumulator and cascade for systolic finite impulse responses (FIRs)</li> <li>Internal coefficient memory banks</li> <li>Preadder/subtractor for improved efficiency</li> <li>Additional pipeline register to increase performance and reduce power</li> <li>Supports floating point arithmetic:         <ul> <li>Perform multiplication, addition, subtraction, multiply-add, multiply-subtract, and complex multiplication.</li> <li>Supports multiplication with accumulation capability, cascade summation, and cascade subtraction capability.</li> <li>Dynamic accumulator reset control.</li> <li>Support direct vector dot and complex multiplication chaining multiply floating point DSP blocks.</li> </ul> </li> </ul>
	Memory controller	DDR4, DDR3, and DDR3L
	PCI Express*	PCI Express (PCIe*) Gen3 (x1, x2, x4, or x8), Gen2 (x1, x2, x4, or x8) and Gen1 (x1, x2, x4, or x8) hard IP with complete protocol stack, endpoint, and root port
	Transceiver I/O	<ul> <li>10GBASE-KR/40GBASE-KR4 Forward Error Correction (FEC)</li> <li>PCS hard IPs that support: <ul> <li>10-Gbps Ethernet (10GbE)</li> <li>PCIe PIPE interface</li> <li>Interlaken</li> <li>Gbps Ethernet (GbE)</li> <li>Common Public Radio Interface (CPRI) with deterministic latency support</li> <li>Gigabit-capable passive optical network (GPON) with fast lock-time support</li> </ul> </li> <li>13.5G JESD204b</li> <li>8B/10B, 64B/66B, 64B/67B encoders and decoders</li> <li>Custom mode support for proprietary protocols</li> </ul>
Core clock networks	<ul> <li>667 MHz externa</li> <li>800 MHz LVDS in</li> <li>Global, regional, and</li> </ul>	c clocking, depending on the application: I memory interface clocking with 2,400 Mbps DDR4 interface terface clocking with 1,600 Mbps LVDS interface I peripheral clock networks are not used can be gated to reduce dynamic power
Phase-locked loops (PLLs)	<ul> <li>Support integer r</li> <li>Fractional mode s</li> <li>Integer PLLs:         <ul> <li>Adjacent to gene</li> </ul> </li> </ul>	nthesis, clock delay compensation, and zero delay buffering (ZDB) node and fractional mode support with third-order delta-sigma modulation
FPGA General-purpose I/Os (GPIOs)	On-chip termination	ry pair can be configured as receiver or transmitter (OCT) -ended LVTTL/LVCMOS interfacing
External Memory Interface	<ul> <li>DDR4—speeds up</li> <li>DDR3—speeds up</li> </ul>	Iller— DDR4, DDR3, and DDR3L support to 1,200 MHz/2,400 Mbps to 1,067 MHz/2,133 Mbps Ier—provides support for RLDRAM 3 <sup>(2)</sup> , QDR IV <sup>(2)</sup> , and QDR II+ <b>continued</b>



#### **Maximum Resources**

# Table 5.Maximum Resource Counts for Intel Arria 10 GX Devices (GX 160, GX 220, GX<br/>270, GX 320, and GX 480)

Resource			Product Line							
		GX 160	GX 220	GX 270	GX 320	GX 480				
Logic Elements	(LE) (K)	160	220	270	320	480				
ALM		61,510	80,330	101,620	119,900	183,590				
Register		246,040	321,320	406,480	479,600	734,360				
Memory (Kb)	M20K	8,800	11,740	15,000	17,820	28,620				
	MLAB	1,050	1,690	2,452	2,727	4,164				
Variable-precision DSP Block		156	6 192 830 985		985	1,368				
18 x 19 Multipli	er	312	384 1,660		1,970	2,736				
PLL	Fractional Synthesis	6	6	8	8	12				
	I/O	6	6	8	8	12				
17.4 Gbps Trans	sceiver	12	12	24	24	36				
GPIO <sup>(3)</sup>		288	288	384	384	492				
LVDS Pair <sup>(4)</sup>		120	120	168	168	222				
PCIe Hard IP Bl	ock	1	1	2	2	2				
Hard Memory C	ontroller	6	6	8	8	12				

<sup>&</sup>lt;sup>(3)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

<sup>&</sup>lt;sup>(4)</sup> Each LVDS I/O pair can be used as differential input or output.



# Table 6.Maximum Resource Counts for Intel Arria 10 GX Devices (GX 570, GX 660, GX 900, and GX 1150)

Re	source		Product Line								
		GX 570	GX 660	GX 900	GX 1150						
Logic Elements	s (LE) (K)	570	660	900	1,150						
ALM		217,080	251,680	339,620	427,200						
Register		868,320	1,006,720	1,358,480	1,708,800						
Memory (Kb)	M20K	36,000	42,620	48,460	54,260						
	MLAB	5,096	5,788	9,386	12,984						
Variable-precis	Variable-precision DSP Block		1,687	1,518	1,518						
18 x 19 Multip	lier	3,046	3,374	3,036	3,036						
PLL	Fractional Synthesis	16	16	32	32						
	I/O	16	16	16	16						
17.4 Gbps Trai	nsceiver	48	48	96	96						
GPIO <sup>(3)</sup>		696	696	768	768						
LVDS Pair <sup>(4)</sup>		324	324	384	384						
PCIe Hard IP E	Block	2	2	4	4						
Hard Memory	Controller	16	16	16	16						

# Package Plan

## Table 7.Package Plan for Intel Arria 10 GX Devices (U19, F27, and F29)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

Product Line	U19 (19 mm × 19 mm, 484-pin UBGA)				F27 mm × 27 n 72-pin FBG/		F29 (29 mm × 29 mm, 780-pin FBGA)			
	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	
GX 160	48	192	6	48	192	12	48	240	12	
GX 220	48	192	6	48	192	12	48	240	12	
GX 270	-	-	_	48	192	12	48	312	12	
GX 320	-	-	_	48	192	12	48	312	12	
GX 480	_	_	_	_	_	_	48	312	12	



#### Table 8. Package Plan for Intel Arria 10 GX Devices (F34, F35, NF40, and KF40)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

Product Line	F34 (35 mm × 35 mm, 1152-pin FBGA)			F35 (35 mm × 35 mm, 1152-pin FBGA)			KF40 (40 mm × 40 mm, 1517-pin FBGA)			NF40 (40 mm × 40 mm, 1517-pin FBGA)		
	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR
GX 270	48	336	24	48	336	24	_	_	_	_	-	-
GX 320	48	336	24	48	336	24	_	-	_	_	-	-
GX 480	48	444	24	48	348	36	_	-	-	_	-	-
GX 570	48	444	24	48	348	36	96	600	36	48	540	48
GX 660	48	444	24	48	348	36	96	600	36	48	540	48
GX 900	-	504	24	-	-	-	_	-	-	_	600	48
GX 1150	-	504	24	-	-	-	_	-	-	_	600	48

#### Table 9. Package Plan for Intel Arria 10 GX Devices (RF40, NF45, SF45, and UF45)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

Product Line	RF40 (40 mm × 40 mm, 1517-pin FBGA)			NF45 (45 mm × 45 mm) 1932-pin FBGA)			SF45 (45 mm × 45 mm) 1932-pin FBGA)			UF45 (45 mm × 45 mm) 1932-pin FBGA)		
	3 V I/O	LVDS I/O	XCVR									
GX 900	_	342	66	_	768	48	_	624	72	_	480	96
GX 1150	_	342	66	_	768	48	_	624	72	_	480	96

#### **Related Information**

I/O and High-Speed Differential I/O Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook

Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.

### **Intel Arria 10 GT**

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 GT devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

#### **Related Information**

#### Intel FPGA Product Selector

Provides the latest information on Intel products.



#### **Maximum Resources**

#### Table 12. Maximum Resource Counts for Intel Arria 10 SX Devices

Resource			Product Line									
		SX 160	SX 220	SX 270	SX 320	SX 480	SX 570	SX 660				
Logic Elements	s (LE) (K)	160	220	270	320	480	570	660				
ALM		61,510	80,330	101,620	119,900	183,590	217,080	251,680				
Register		246,040	321,320	406,480	479,600	734,360	868,320	1,006,720				
Memory (Kb)	M20K	8,800	11,740	15,000	17,820	28,620	36,000	42,620				
	MLAB	1,050	1,690	2,452	2,727	4,164	5,096	5,788				
Variable-precision DSP Block		156	192	830	985	1,368	1,523	1,687				
18 x 19 Multip	lier	312	384	1,660	1,970	2,736	3,046	3,374				
PLL	Fractional Synthesis	6	6	8	8	12	16	16				
	I/O	6	6	8	8	12	16	16				
17.4 Gbps Tra	nsceiver	12	12	24	24	36	48	48				
GPIO <sup>(8)</sup>		288	288	384	384	492	696	696				
LVDS Pair <sup>(9)</sup>		120	120	168	168	174	324	324				
PCIe Hard IP E	Block	1	1	2	2	2	2	2				
Hard Memory	Controller	6	6	8	8	12	16	16				
ARM Cortex-A9 MPCore Processor		Yes	Yes	Yes	Yes	Yes	Yes	Yes				

#### Package Plan

## Table 13.Package Plan for Intel Arria 10 SX Devices (U19, F27, F29, and F34)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

Product Line	U19 (19 mm × 19 mm, 484-pin UBGA)		(19 mm × 19 mm, (27 mm × 27 mm,		F29 (29 mm × 29 mm, 780-pin FBGA)		F34 (35 mm × 35 mm, 1152-pin FBGA)					
	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR
SX 160	48	144	6	48	192	12	48	240	12	_	-	-
SX 220	48	144	6	48	192	12	48	240	12	_	-	-
SX 270	-	-	_	48	192	12	48	312	12	48	336	24
SX 320	-	-	_	48	192	12	48	312	12	48	336	24
											conti	nued

<sup>&</sup>lt;sup>(8)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

<sup>(9)</sup> Each LVDS I/O pair can be used as differential input or output.



# I/O Vertical Migration for Intel Arria 10 Devices

#### Figure 4. Migration Capability Across Intel Arria 10 Product Lines

- The arrows indicate the migration paths. The devices included in each vertical migration path are shaded. Devices with fewer resources in the same path have lighter shades.
- To achieve the full I/O migration across product lines in the same migration path, restrict I/Os and transceivers usage to match the product line with the lowest I/O and transceiver counts.
- An LVDS I/O bank in the source device may be mapped to a 3 V I/O bank in the target device. To use
  memory interface clock frequency higher than 533 MHz, assign external memory interface pins only to
  banks that are LVDS I/O in both devices.
- There may be nominal 0.15 mm package height difference between some product lines in the same package type.
  - Package Product Variant Line U19 F27 KF40 NF40 RF40 NF45 SF45 UF45 F29 F34 F35 GX 160 GX 220 GX 270 GX 320 Intel® Arria® 10 GX GX 480 GX 570 GX 660 GX 900 GX 1150 GT 900 Intel Arria 10 GT GT 1150 SX 160 SX 220 SX 270 Intel Arria 10 SX SX 320 SX 480 SX 570 SX 660
- Some migration paths are not shown in the Intel Quartus Prime software Pin Migration View.

*Note:* To verify the pin migration compatibility, use the **Pin Migration View** window in the Intel Quartus Prime software Pin Planner.

# **Adaptive Logic Module**

Intel Arria 10 devices use a 20 nm ALM as the basic building block of the logic fabric.

The ALM architecture is the same as the previous generation FPGAs, allowing for efficient implementation of logic functions and easy conversion of IP between the device generations.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than the traditional two-register per LUT architecture.



Features for floating-point arithmetic:

- A completely hardened architecture that supports multiplication, addition, subtraction, multiply-add, and multiply-subtract
- Multiplication with accumulation capability and a dynamic accumulator reset control
- Multiplication with cascade summation capability
- Multiplication with cascade subtraction capability
- Complex multiplication
- Direct vector dot product
- Systolic FIR filter

#### Table 15. Variable-Precision DSP Block Configurations for Intel Arria 10 Devices

Usage Example	Multiplier Size (Bit)	DSP Block Resources
Medium precision fixed point	Two 18 x 19	1
High precision fixed or Single precision floating point	One 27 x 27	1
Fixed point FFTs	One 19 x 36 with external adder	1
Very high precision fixed point	One 36 x 36 with external adder	2
Double precision floating point	One 54 x 54 with external adder	4

#### Table 16. Resources for Fixed-Point Arithmetic in Intel Arria 10 Devices

The table lists the variable-precision DSP resources by bit precision for each Intel Arria 10 device.

Variant	Variant Product Line		Independent Input and Output Multiplications Operator		18 x 19 Multiplier Adder Sum	18 x 18 Multiplier Adder
		DSP Block	18 x 19 Multiplier	27 x 27 Multiplier	Mode	Summed with 36 bit Input
AIntel Arria 10 GX	GX 160	156	312	156	156	156
GX	GX 220	192	384	192	192	192
	GX 270	830	1,660	830	830	830
	GX 320	984	1,968	984	984	984
	GX 480	1,368	2,736	1,368	1,368	1,368
	GX 570	1,523	3,046	1,523	1,523	1,523
	GX 660	1,687	3,374	1,687	1,687	1,687
	GX 900	1,518	3,036	1,518	1,518	1,518
	GX 1150	1,518	3,036	1,518	1,518	1,518
Intel Arria 10	GT 900	1,518	3,036	1,518	1,518	1,518
GT	GT 1150	1,518	3,036	1,518	1,518	1,518
Intel Arria 10	SX 160	156	312	156	156	156
SX	SX 220	192	384	192	192	192
	SX 270	830	1,660	830	830	830
						continued



Variant	Product Line	Variable- precision Multiplications Oper			18 x 19 Multiplier	18 x 18 Multiplier
		DSP Block	18 x 19 Multiplier	27 x 27 Multiplier	Adder Sum Mode	Adder Summed with 36 bit Input
	SX 320	984	1,968	984	984	984
	SX 480	1,368	2,736	1,368	1,368	1,368
	SX 570	1,523	3,046	1,523	1,523	1,523
	SX 660	1,687	3,374	1,687	1,687	1,687

#### Table 17. Resources for Floating-Point Arithmetic in Intel Arria 10 Devices

The table lists the variable-precision DSP resources by bit precision for each Intel Arria 10 device.

Variant	Product Line	Variable- precision DSP Block	Single Precision Floating-Point Multiplication Mode	Single-Precision Floating-Point Adder Mode	Single- Precision Floating-Point Multiply Accumulate Mode	Peak Giga Floating- Point Operations per Second (GFLOPs)
Intel Arria 10 GX	GX 160	156	156	156	156	140
GA	GX 220	192	192	192	192	173
	GX 270	830	830	830	830	747
	GX 320	984	984	984	984	886
	GX 480	1,369	1,368	1,368	1,368	1,231
	GX 570	1,523	1,523	1,523	1,523	1,371
	GX 660	1,687	1,687	1,687	1,687	1,518
	GX 900	1,518	1,518	1,518	1,518	1,366
	GX 1150	1,518	1,518	1,518	1,518	1,366
Intel Arria 10	GT 900	1,518	1,518	1,518	1,518	1,366
GT	GT 1150	1,518	1,518	1,518	1,518	1,366
Intel Arria 10	SX 160	156	156	156	156	140
SX	SX 220	192	192	192	192	173
	SX 270	830	830	830	830	747
	SX 320	984	984	984	984	886
	SX 480	1,369	1,368	1,368	1,368	1,231
	SX 570	1,523	1,523	1,523	1,523	1,371
	SX 660	1,687	1,687	1,687	1,687	1,518

# **Embedded Memory Blocks**

The embedded memory blocks in the devices are flexible and designed to provide an optimal amount of small- and large-sized memory arrays to fit your design requirements.



# **Types of Embedded Memory**

The Intel Arria 10 devices contain two types of memory blocks:

- 20 Kb M20K blocks—blocks of dedicated memory resources. The M20K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide and shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Intel Arria 10 devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB.

# **Embedded Memory Capacity in Intel Arria 10 Devices**

	Product	M2	:0K	ML	AB	Total RAM Bit
Variant	Line	Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	(Kb)
Intel Arria 10 GX	GX 160	440	8,800	1,680	1,050	9,850
	GX 220	587	11,740	2,703	1,690	13,430
	GX 270	750	15,000	3,922	2,452	17,452
	GX 320	891	17,820	4,363	2,727	20,547
	GX 480	1,431	28,620	6,662	4,164	32,784
	GX 570	1,800	36,000	8,153	5,096	41,096
	GX 660	2,131	42,620	9,260	5,788	48,408
	GX 900	2,423	48,460	15,017	9,386	57,846
	GX 1150	2,713	54,260	20,774	12,984	67,244
Intel Arria 10 GT	GT 900	2,423	48,460	15,017	9,386	57,846
	GT 1150	2,713	54,260	20,774	12,984	67,244
Intel Arria 10 SX	SX 160	440	8,800	1,680	1,050	9,850
	SX 220	587	11,740	2,703	1,690	13,430
	SX 270	750	15,000	3,922	2,452	17,452
	SX 320	891	17,820	4,363	2,727	20,547
	SX 480	1,431	28,620	6,662	4,164	32,784
	SX 570	1,800	36,000	8,153	5,096	41,096
	SX 660	2,131	42,620	9,260	5,788	48,408

#### Table 18. Embedded Memory Capacity and Distribution in Intel Arria 10 Devices



# **Embedded Memory Configurations for Single-port Mode**

#### Table 19. Single-port Embedded Memory Configurations for Intel Arria 10 Devices

This table lists the maximum configurations supported for single-port RAM and ROM modes.

Memory Block	Depth (bits)	Programmable Width
MLAB	32	x16, x18, or x20
	64 (10)	x8, x9, x10
М20К	512	x40, x32
	1К	x20, x16
	2К	x10, x8
	4К	x5, x4
	8К	x2
	16K	×1

# **Clock Networks and PLL Clock Sources**

The clock network architecture is based on Intel's global, regional, and peripheral clock structure. This clock structure is supported by dedicated clock input pins, fractional clock synthesis PLLs, and integer I/O PLLs.

#### **Clock Networks**

The Intel Arria 10 core clock networks are capable of up to 800 MHz fabric operation across the full industrial temperature range. For the external memory interface, the clock network supports the hard memory controller with speeds up to 2,400 Mbps in a quarter-rate transfer.

To reduce power consumption, the Intel Quartus Prime software identifies all unused sections of the clock network and powers them down.

### **Fractional Synthesis and I/O PLLs**

Intel Arria 10 devices contain up to 32 fractional synthesis PLLs and up to 16 I/O PLLs that are available for both specific and general purpose uses in the core:

- Fractional synthesis PLLs—located in the column adjacent to the transceiver blocks
- I/O PLLs—located in each bank of the 48 I/Os

#### **Fractional Synthesis PLLs**

You can use the fractional synthesis PLLs to:

- Reduce the number of oscillators that are required on your board
- Reduce the number of clock pins that are used in the device by synthesizing multiple clock frequencies from a single reference clock source

<sup>&</sup>lt;sup>(10)</sup> Supported through software emulation and consumes additional MLAB blocks.



#### Table 20. Memory Standards Supported by the Hard Memory Controller

This table lists the overall capability of the hard memory controller. For specific details, refer to the External Memory Interface Spec Estimator and Intel Arria 10 Device Datasheet.

Memory Standard	Rate Support	Ping Pong PHY Support	Maximum Frequency (MHz)
DDR4 SDRAM	Quarter rate	Yes	1,067
		_	1,200
DDR3 SDRAM	Half rate	Yes	533
		_	667
	Quarter rate	Yes	1,067
		_	1,067
DDR3L SDRAM	Half rate	Yes	533
		_	667
	Quarter rate	Yes	933
		_	933
LPDDR3 SDRAM	Half rate	-	533
	Quarter rate	_	800

#### Table 21. Memory Standards Supported by the Soft Memory Controller

Memory Standard	Rate Support	Maximum Frequency (MHz)
RLDRAM 3 (11)	Quarter rate	1,200
QDR IV SRAM <sup>(11)</sup>	Quarter rate	1,067
QDR II SRAM	Full rate	333
	Half rate	633
QDR II+ SRAM	Full rate	333
	Half rate	633
QDR II+ Xtreme SRAM	Full rate	333
	Half rate	633

#### Table 22. Memory Standards Supported by the HPS Hard Memory Controller

The hard processor system (HPS) is available in Intel Arria 10 SoC devices only.

Memory Standard	Rate Support	Maximum Frequency (MHz)
DDR4 SDRAM	Half rate	1,200
DDR3 SDRAM	Half rate	1,067
DDR3L SDRAM	Half rate	933

<sup>&</sup>lt;sup>(11)</sup> Intel Arria 10 devices support this external memory interface using hard PHY with soft memory controller.



Each transceiver channel contains a channel PLL that can be used as the CMU PLL or clock data recovery (CDR) PLL. In CDR mode, the channel PLL recovers the receiver clock and data in the transceiver channel. Up to 80 independent data rates can be configured on a single Intel Arria 10 device.

#### Table 23. PMA Features of the Transceivers in Intel Arria 10 Devices

Feature	Capability
Chip-to-Chip Data Rates	1 Gbps to 17.4 Gbps (Intel Arria 10 GX devices) 1 Gbps to 25.8 Gbps (Intel Arria 10 GT devices)
Backplane Support	Drive backplanes at data rates up to 12.5 Gbps
Optical Module Support	SFP+/SFP, XFP, CXP, QSFP/QSFP28, CFP/CFP2/CFP4
Cable Driving Support	SFP+ Direct Attach, PCI Express over cable, eSATA
Transmit Pre-Emphasis	4-tap transmit pre-emphasis and de-emphasis to compensate for system channel loss
Continuous Time Linear Equalizer (CTLE)	Dual mode, high-gain, and high-data rate, linear receive equalization to compensate for system channel loss
Decision Feedback Equalizer (DFE)	7-fixed and 4-floating tap DFE to equalize backplane channel loss in the presence of crosstalk and noisy environments
Variable Gain Amplifier	Optimizes the signal amplitude prior to the CDR sampling and operates in fixed and adaptive modes
Altera Digital Adaptive Parametric Tuning (ADAPT)	Fully digital adaptation engine to automatically adjust all link equalization parameters— including CTLE, DFE, and variable gain amplifier blocks—that provide optimal link margin without intervention from user logic
Precision Signal Integrity Calibration Engine (PreSICE)	Hardened calibration controller to quickly calibrate all transceiver control parameters on power-up, which provides the optimal signal integrity and jitter performance
Advanced Transmit (ATX) PLL	Low jitter ATX (LC tank based) PLLs with continuous tuning range to cover a wide range of standard and proprietary protocols
Fractional PLLs	On-chip fractional frequency synthesizers to replace on-board crystal oscillators and reduce system cost
Digitally Assisted Analog CDR	Superior jitter tolerance with fast lock time
Dynamic Partial Reconfiguration	Allows independent control of the Avalon memory-mapped interface of each transceiver channel for the highest transceiver flexibility
Multiple PCS-PMA and PCS- PLD interface widths	8-, 10-, 16-, 20-, 32-, 40-, or 64-bit interface widths for flexibility of deserialization width, encoding, and reduced latency

## **PCS Features**

This table summarizes the Intel Arria 10 transceiver PCS features. You can use the transceiver PCS to support a wide range of protocols ranging from 1 Gbps to 25.8 Gbps.



Protocol	Data Rate (Gbps)	Transceiver IP	PCS Support
CPRI 6.0 (64B/66B)	0.6144 to 10.1376	Native PHY	Enhanced PCS
CPRI 4.2 (8B/10B)	0.6144 to 9.8304	Native PHY	Standard PCS
OBSAI RP3 v4.2	0.6144 to 6.144	Native PHY	Standard PCS
SD-SDI/HD-SDI/3G-SDI	0.143 <sup>(12)</sup> to 2.97	Native PHY	Standard PCS

#### **Related Information**

#### Intel Arria 10 Transceiver PHY User Guide

Provides more information about the supported transceiver protocols and PHY IP, the PMA architecture, and the standard, enhanced, and PCIe Gen3 PCS architecture.

# SoC with Hard Processor System

Each SoC device combines an FPGA fabric and a hard processor system (HPS) in a single device. This combination delivers the flexibility of programmable logic with the power and cost savings of hard IP in these ways:

- Reduces board space, system power, and bill of materials cost by eliminating a discrete embedded processor
- Allows you to differentiate the end product in both hardware and software, and to support virtually any interface standard
- Extends the product life and revenue through in-field hardware and software updates

<sup>&</sup>lt;sup>(12)</sup> The 0.143 Gbps data rate is supported using oversampling of user logic that you must implement in the FPGA fabric.



#### **System Peripherals and Debug Access Port**

Each Ethernet MAC, USB OTG, NAND flash controller, and SD/MMC controller module has an integrated DMA controller. For modules without an integrated DMA controller, an additional DMA controller module provides up to eight channels of high-bandwidth data transfers. Peripherals that communicate off-chip are multiplexed with other peripherals at the HPS pin level. This allows you to choose which peripherals interface with other devices on your PCB.

The debug access port provides interfaces to industry standard JTAG debug probes and supports ARM CoreSight debug and core traces to facilitate software development.

#### **HPS-FPGA AXI Bridges**

The HPS–FPGA bridges, which support the Advanced Microcontroller Bus Architecture (AMBA) Advanced eXtensible Interface (AXI<sup>m</sup>) specifications, consist of the following bridges:

- FPGA-to-HPS AMBA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the FPGA fabric to issue transactions to slaves in the HPS.
- HPS-to-FPGA Avalon/AMBA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the HPS to issue transactions to slaves in the FPGA fabric.
- Lightweight HPS-to-FPGA AXI bridge—a lower latency 32 bit width bus that allows the HPS to issue transactions to soft peripherals in the FPGA fabric. This bridge is primarily used for control and status register (CSR) accesses to peripherals in the FPGA fabric.

The HPS–FPGA AXI bridges allow masters in the FPGA fabric to communicate with slaves in the HPS logic, and vice versa. For example, the HPS-to-FPGA AXI bridge allows you to share memories instantiated in the FPGA fabric with one or both microprocessors in the HPS, while the FPGA-to-HPS AXI bridge allows logic in the FPGA fabric to access the memory and peripherals in the HPS.

Each HPS–FPGA bridge also provides asynchronous clock crossing for data transferred between the FPGA fabric and the HPS.

#### **HPS SDRAM Controller Subsystem**

The HPS SDRAM controller subsystem contains a multiport SDRAM controller and DDR PHY that are shared between the FPGA fabric (through the FPGA-to-HPS SDRAM interface), the level 2 (L2) cache, and the level 3 (L3) system interconnect. The FPGA-to-HPS SDRAM interface supports AMBA AXI and Avalon<sup>®</sup> Memory-Mapped (Avalon-MM) interface standards, and provides up to six individual ports for access by masters implemented in the FPGA fabric.

The HPS SDRAM controller supports up to 3 masters (command ports), 3x 64-bit read data ports and 3x 64-bit write data ports.

To maximize memory performance, the SDRAM controller subsystem supports command and data reordering, deficit round-robin arbitration with aging, and high-priority bypass features.



Instead of placing all device functions in the FPGA fabric, you can store some functions that do not run simultaneously in external memory and load them only when required. This capability increases the effective logic density of the device, and lowers cost and power consumption.

In the Intel solution, you do not have to worry about intricate device architecture to perform a partial reconfiguration. The partial reconfiguration capability is built into the Intel Quartus Prime design software, making such time-intensive task simple.

Intel Arria 10 devices support partial reconfiguration in the following configuration options:

- Using an internal host:
  - All supported configuration modes where the FPGA has access to external memory devices such as serial and parallel flash memory.
  - Configuration via Protocol [CvP (PCIe)]
- Using an external host—passive serial (PS), fast passive parallel (FPP) x8, FPP x16, and FPP x32 I/O interface.

# **Enhanced Configuration and Configuration via Protocol**

#### Table 25. Configuration Schemes and Features of Intel Arria 10 Devices

Intel Arria 10 devices support 1.8 V programming voltage and several configuration schemes.

Scheme	Data Width	Max Clock Rate (MHz)	Max Data Rate (Mbps) (13)	Decompression	Design Security <sup>(1</sup> 4)	Partial Reconfiguration (15)	Remote System Update
JTAG	1 bit	33	33	_	-	Yes <sup>(16)</sup>	-
Active Serial (AS) through the EPCQ-L configuration device	1 bit, 4 bits	100	400	Yes	Yes	Yes <sup>(16)</sup>	Yes
Passive serial (PS) through CPLD or external microcontroller	1 bit	100	100	Yes	Yes	Yes <sup>(16)</sup>	Parallel Flash Loader (PFL) IP core
continued							ntinued

<sup>&</sup>lt;sup>(13)</sup> Enabling either compression or design security features affects the maximum data rate. Refer to the Intel Arria 10 Device Datasheet for more information.

<sup>&</sup>lt;sup>(14)</sup> Encryption and compression cannot be used simultaneously.

<sup>&</sup>lt;sup>(15)</sup> Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Intel for support.

<sup>&</sup>lt;sup>(16)</sup> Partial configuration can be performed only when it is configured as internal host.

#### Intel<sup>®</sup> Arria<sup>®</sup> 10 Device Overview A10-OVERVIEW | 2018.04.09



September 2017 July 2017 July 2017 May 2017 May 2017 March 2017	2017.09.20 2017.07.13 2017.07.06 2017.05.08	<ul> <li>Removed package code 40, low static power, SmartVID, industrial, and military operating temperature support from <i>Sample Ordering Core and Available Options for Intel Arria 10 GT Devices</i> figure.</li> <li>Updated short reach transceiver rate for Intel Arria 10 GT devices to 25.8 Gbps.</li> <li>Removed On-Die Instrumentation — EyeQ and Jitter Margin Tool support from <i>PMA Features of the Transceivers in Intel Arria 10 Devices</i> table.</li> <li>Updated the maximum speed of the DDR4 external memory interface from 1,333 MHz/2,666 Mbps to 1,200 MHz/2,400 Mbps.</li> <li>Corrected the automotive temperature range in the figure showing the available options for the Intel Arria 10 GX devices from "-40°C to 100°C" to "-40°C to 125°C".</li> <li>Added automotive temperature option to Intel Arria 10 GX device family.</li> <li>Corrected protocol names with "1588" to "IEEE 1588v2".</li> <li>Updated the vertical migration table to remove vertical migration between Intel Arria 10 GX and Intel Arria 10 SX device variants.</li> </ul>
July 2017 July 2017 May 2017	2017.07.13 2017.07.06 2017.05.08	<ul> <li>1,333 MHz/2,666 Mbps to 1,200 MHz/2,400 Mbps.</li> <li>Corrected the automotive temperature range in the figure showing the available options for the Intel Arria 10 GX devices from "-40°C to 100°C" to "-40°C to 125°C".</li> <li>Added automotive temperature option to Intel Arria 10 GX device family.</li> <li>Corrected protocol names with "1588" to "IEEE 1588v2".</li> <li>Updated the vertical migration table to remove vertical migration</li> </ul>
July 2017 May 2017	2017.07.06 2017.05.08	<ul> <li>available options for the Intel Arria 10 GX devices from "-40°C to 100°C" to "-40°C to 125°C".</li> <li>Added automotive temperature option to Intel Arria 10 GX device family.</li> <li>Corrected protocol names with "1588" to "IEEE 1588v2".</li> <li>Updated the vertical migration table to remove vertical migration</li> </ul>
May 2017	2017.05.08	<ul> <li>Corrected protocol names with "1588" to "IEEE 1588v2".</li> <li>Updated the vertical migration table to remove vertical migration</li> </ul>
		Updated the vertical migration table to remove vertical migration
March 2017		Removed all "Preliminary" marks.
	2017.03.15	<ul> <li>Removed the topic about migration from Intel Arria 10 to Intel Stratix 10 devices.</li> <li>Rebranded as Intel.</li> </ul>
October 2016	2016.10.31	<ul> <li>Removed package F36 from Intel Arria 10 GX devices.</li> <li>Updated Intel Arria 10 GT sample ordering code and maximum GX transceiver count. Intel Arria 10 GT devices are available only in the SF45 package option with a maximum of 72 transceivers.</li> </ul>
May 2016	2016.05.02	<ul> <li>Updated the FPGA Configuration and HPS Booting topic.</li> <li>Remove V<sub>CC</sub> PowerManager from the Summary of Features, Power Management and Arria 10 Device Variants and packages topics. This feature is no longer supported in Arria 10 devices.</li> <li>Removed LPDDR3 from the Memory Standards Supported by the HPS Hard Memory Controller table in the Memory Standards Supported by Intel Arria 10 Devices topic. This standard is only supported by the FPGA.</li> <li>Removed transceiver speed grade 5 from the Device Variants and Packages topic for Arria 10 GX and SX devices.</li> </ul>
February 2016	2016.02.11	<ul> <li>Changed the maximum Arria 10 GT datarate to 25.8 Gbps and the minimum datarate to 1 Gbps globally.</li> <li>Revised the state for Core clock networks in the Summary of Features topic.</li> <li>Changed the transceiver parameters in the "Summary of Features for Arria 10 Devices" table.</li> <li>Changed the transceiver parameters in the "Maximum Resource Counts for Arria 10 GT Devices" table.</li> <li>Changed the package availability for GT devices in the "Package Plan for Arria 10 GT Devices" table.</li> <li>Changed the package configurations for GT devices in the "Migration Capability Across Arria 10 Product Lines" figure.</li> <li>Changed the transceiver parameters in the "Low Power Serial Transceivers" section.</li> <li>Changed the transceiver descriptions in the "Device Variants for the Arria 10 Device Family" table.</li> <li>Changed the "Sample Ordering Code and Available Options for Arria 10 GT Devices" figure.</li> <li>Changed the datarates for GT devices in the "PMA Features" section.</li> <li>Changed the datarates for GT devices in the "PCS Features" section.</li> </ul>

#### Intel<sup>®</sup> Arria<sup>®</sup> 10 Device Overview A10-OVERVIEW | 2018.04.09



Date	Version	Changes	
December 2015	2015.12.14	• Updated the number of M20K memory blocks for Arria 10 GX 660 from 2133 to 2131 and corrected the total RAM bit from 48,448 Kb to 48,408 Kb.	
		Corrected the number of DSP blocks for Arria 10 GX 660 from 1688 to 1687 in the table listing floating-point arithmetic resources.	
November 2015	2015.11.02	• Updated the maximum resources for Arria 10 GX 220, GX 320, GX 480, GX 660, SX 220, SX 320, SX 480, and SX 660.	
		Updated resource count for Arria 10 GX 320, GX 480, GX 660, SX 320, SX 480, a SX 660 devices in <b>Number of Multipliers in Intel Arria 10</b> <b>Devices</b> table.	
		<ul><li>Updated the available options for Arria 10 GX, GT, and SX.</li><li>Changed instances of <i>Quartus II</i> to <i>Quartus Prime</i>.</li></ul>	
June 2015	2015.06.15	Corrected label for Intel Arria 10 GT product lines in the vertical migratior figure.	
May 2015	2015.05.15	Corrected the DDR3 half rate and quarter rate maximum frequencies in the table that lists the memory standards supported by the Intel Arria 10 hard memory controller.	
May 2015	2015.05.04	<ul> <li>Added support for 13.5G JESD204b in the Summary of Features table.</li> <li>Added a link to Arria 10 GT Channel Usage in the Arria 10 GT Package Plan topic.</li> </ul>	
		Added a note to the table, Maximum Resource Counts for Arria 10 GT devices.	
		Updated the power requirements of the transceivers in the Low Power Serial Transceivers topic.	
January 2015	2015.01.23	Added floating point arithmetic features in the Summary of Features table.	
		• Updated the total embedded memory from 38.38 megabits (Mb) to 65.6 Mb.	
		Updated the table that lists the memory standards supported by Intel Arria 10 devices.	
		<ul> <li>Removed support for DDR3U, LPDDR3 SDRAM, RLDRAM 2, and DDR2.</li> <li>Moved RLDRAM 3 support from hard memory controller to soft memory controller. RLDRAM 3 support uses hard PHY with soft memory controller.</li> </ul>	
		Added soft memory controller support for QDR IV.	
		• Updated the maximum resource count table to include the number of hard memory controllers available in each device variant.	
		• Updated the transceiver PCS data rate from 12.5 Gbps to 12 Gbps.	
		Updated the max clock rate of PS, FPP x8, FPP x16, and Configuration via HPS from 125 MHz to 100 MHz.	
		Added a feature for fractional synthesis PLLs: PLL cascading.	
		Updated the HPS programmable general-purpose I/Os from 54 to 62.	
September 2014	2014.09.30	• Corrected the 3 V I/O and LVDS I/O counts for F35 and F36 packages of Arria 10 GX.	
		• Corrected the 3 V I/O, LVDS I/O, and transceiver counts for the NF40 package of the Arria GX 570 and 660.	
		<ul> <li>Removed 3 V I/O, LVDS I/O, and transceiver counts for the NF40 package of the Arria GX 900 and 1150. The NF40 package is not available for Arria 10 GX 900 and 1150.</li> </ul>	
		continued	